**32-bit transparant D-type latch with 5 V tolerant inputs/outputs; 3-state** 

Rev. 4 — 28 January 2013

**Product data sheet** 

### 1. General description

The 74LVCH32373A is a 32-bit transparent D-type latch featuring separate D-type inputs for each latch and 3-state outputs for bus-oriented applications. One latch enable input (nLE) and one output enable input (nOE) are provided for each octal. Inputs can be driven from either 3.3 V or 5 V devices.

The device consists of 4 sections of eight D-type transparent latches with 3-state true outputs. When input nLE is HIGH, data at the nDn inputs enter the latches. In this condition, the latches are transparent, i.e. a latch output changes each time its corresponding D-input changes.

When input nLE is LOW, the latches store the information that was present at the D-inputs one set-up time preceding the HIGH-to-LOW transition of nLE. When input  $n\overline{OE}$  is LOW, the contents of the eight latches are available at the outputs. When input  $n\overline{OE}$  is HIGH, the outputs go to the high-impedance OFF-state. Operation of the  $n\overline{OE}$  input does not affect the state of the latches.

The inputs can be driven from either 3.3 V or 5 V devices. In 3-state operation, outputs can handle 5 V. These features allow the use of these devices in a mixed 3.3 V and 5 V environment.

Bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

### 2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Multibyte flow-through standard pinout architecture
- Multiple low inductance supply pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold
- High impedance when V<sub>CC</sub> = 0 V
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)

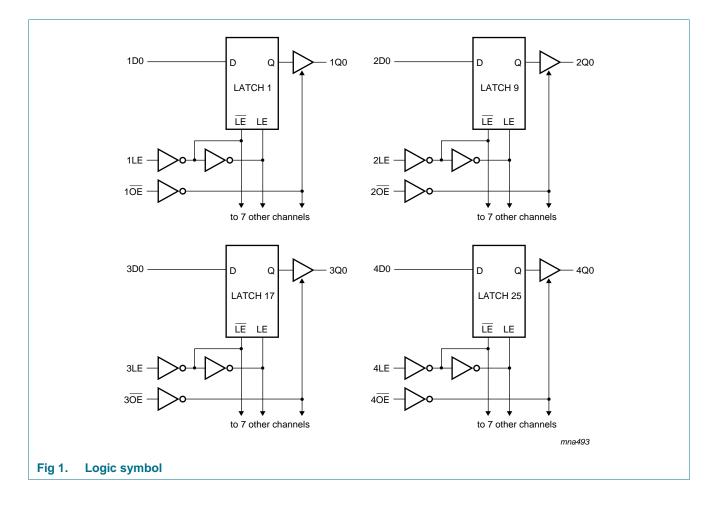


- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from –40 °C to +85 °C and –40 °C to +125 °C
- Packaged in plastic fine-pitch ball grid array package

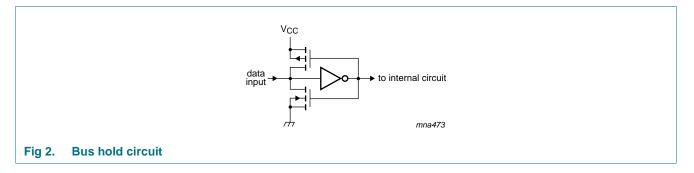
## 3. Ordering information

Table 1.         Ordering information									
Type number Package									
	Temperature range	Name	Description	Version					
74LVCH32372AEC	–40 °C to +125 °C	LFBGA96	plastic low profile fine-pitch ball grid array package; 96 balls; body $13.5 \times 5.5 \times 1.05$ mm	SOT536-1					

## 4. Functional diagram



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## 5. Pinning information

																r	nna492
	6	1D1	1D3	1D5	1D7	2D1	2D3	2D5	2D6	3D1	3D3	3D5	3D7	4D1	4D3	4D5	4D6
	5	1D0	1D2	1D4	1D6	2D0	2D2	2D4	2D7	3D0	3D2	3D4	3D6	4D0	4D2	4D4	4D7
	4	1LE	GND	V <sub>CC</sub>	GND	GND	V <sub>CC</sub>	GND	2LE	3LE	GND	V <sub>CC</sub>	GND	GND	V <sub>CC</sub>	GND	4LE
	3	1 <del>0E</del>	GND	V <sub>CC</sub>	GND	GND	V <sub>CC</sub>	GND	20E	3ŌE	GND	V <sub>CC</sub>	GND	GND	V <sub>CC</sub>	GND	40E
	2	1Q0	1Q2	1Q4	1Q6	2Q0	2Q2	2Q4	2Q7	3Q0	3Q2	3Q4	3Q6	4Q0	4Q2	4Q4	4Q7
	1	1Q1	1Q3	1Q5	1Q7	2Q1	2Q3	2Q5	2Q6	3Q1	3Q3	3Q5	3Q7	4Q1	4Q3	4Q5	4Q6
	L	A	В	С	D	E	F	G	н	J	К	L	М	N	Р	R	т
Fig 3. Pi	n configura	ation	1														

### 5.1 Pinning

### 5.2 Pin description

#### Table 2. **Pin description** Symbol Ball Description $n\overline{OE}$ (n = 1 to 4) A3, H3, J3, T3 output enable input (active LOW) nLE (n = 1 to 4)A4, H4, J4, T4 latch enable input (active HIGH) A5, A6, B5, B6, C5, C6, D5, D6 1D[0:7] data input E5, E6, F5, F6, G5, G6, H6, H5 2D[0:7] data input 3D[0:7] J5, J6, K5, K6, L5, L6, M5, M6 data input 4D[0:7] N5, N6, P5, P6, R5, R6, T6, T5 data input A2, A1, B2, B1, C2, C1, D2, D1 1Q[0:7] data output 2Q[0:7] E2, E1, F2, F1, G2, G1, H1, H2 data output 3Q[0:7] J2, J1, K2, K1, L2, L1, M2, M1 data output 4Q[0:7] N2, N1, P2, P1, R2, R1, T1, T2 data output GND B3, B4, D3, D4, E3, E4, G3, G4, K3, K4, ground (0 V) M3, M4, N3, N4, R3, R4 C3, C4, F3, F4, L3, L4, P3, P4 $V_{CC}$ supply voltage

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## 6. Functional description

#### Table 3.Function table[1]

Operating modes	Inputs		Internal latch	Output	
	nOE	nLE	nDn		nQn
Enable and read register	L	Н	L	L	L
(transparent mode)	L	Н	Н	Н	Н
Latch and read register	L	L	Ι	L	L
	L	L	h	Н	Н
Latch register and disable	Н	L	I	L	Z
outputs	Н	L	h	Н	Z

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition;

Z = High impedance OFF-state.

## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					,
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι <sub>ΟΚ</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	output HIGH or LOW state	[2] -0.5	V <sub>CC</sub> + 0.5	V
		output 3-state	[2] -0.5	+6.5	V
I <sub>O</sub>	output current	$V_{O} = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	200	mA
I <sub>GND</sub>	ground current		-200	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb}$ = -40 °C to +125 °C	<u>[3]</u> _	1000	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] Above 70 °C, the value of  $P_{tot}$  derates linearly with 1.8 mW/K.

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## 8. Recommended operating conditions

Table 5.	Recommended operating condition	ons				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V <sub>CC</sub>	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	-	-	20	ns/V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	-	-	10	ns/V

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	–40 °C to	o +125 ℃	Unit
			Min	Typ[1]	Max	Min	Max	
VIH	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC}$ = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
VIL	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
√ <sub>ОН</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24$ mA; $V_{CC} = 3.0$ V	2.2	-	-	2.0	-	V
/ <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V or GND <sup>[2]</sup>	-	±0.1	±5	-	±20	μΑ

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### 32-bit transparant D-type latch with 5 V tolerant inputs/outputs; 3-state

Symbol	Parameter	Conditions	-	40 °C to +	85 °C	–40 °C	to +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
I <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V};$ $V_{O} = 5.5 \text{ V or } \text{GND}^{[2]}$	-	±0.1	±5	-	±20	μA
I <sub>OFF</sub>	power-off leakage current	$V_{CC}$ = 0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V	-	±0.1	±10	-	±20	μA
I <sub>CC</sub>	supply current	$\label{eq:VCC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	40	-	160	μΑ
Δl <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μA
CI	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V <sub>1</sub> = GND to V <sub>CC</sub>	-	5.0	-	-	-	pF
I <sub>BHL</sub>	bus hold	$V_{CC} = 1.65; V_I = 0.58 V_{[3][4]}$	10	-	-	10	-	μΑ
	LOW current	$V_{CC} = 2.3; V_I = 0.7 V$	30	-	-	25	-	μΑ
		$V_{CC} = 3.0; V_I = 0.8 V$	75	-	-	60	-	μΑ
I <sub>BHH</sub>	bus hold	$V_{CC} = 1.65; V_I = 1.07 V_{[3][4]}$	-10	-	-	-10	-	μΑ
	HIGH current	$V_{CC} = 2.3; V_I = 1.7 V$	-30	-	-	-25	-	μΑ
		$V_{CC} = 3.0; V_I = 2.0 V$	-75	-	-	-60	-	μΑ
I <sub>BHLO</sub>	bus hold	V <sub>CC</sub> = 1.95 V <sup>[3][5]</sup>	200	-	-	200	-	μΑ
	LOW overdrive	$V_{CC} = 2.7 V$	300	-	-	300	-	μΑ
	current	V <sub>CC</sub> = 3.6 V	500	-	-	500	-	μΑ
I <sub>BHHO</sub>	bus hold	V <sub>CC</sub> = 1.95 V <sup>[3][5]</sup>	-200	-	-	-200	-	μA
	HIGH	V <sub>CC</sub> = 2.7 V	-300	-	-	-300	-	μA
	overdrive current	V <sub>CC</sub> = 3.6 V	-500	-	-	-500	-	μA

#### Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V)

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C.

[2] The bus hold circuit is switched off when  $V_I > V_{CC}$  allowing 5.5 V on the input pin.

[3] Valid for data inputs only. Control inputs do not have a bus hold circuit.

[4] The specified sustaining current at the data input holds the input below the specified V<sub>1</sub> level.

[5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

## **10.** Dynamic characteristics

### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		T <sub>amb</sub> =	–40 °C to	+85 °C	–40 °C to	o +125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>pd</sub>	propagation	Dn to Qn; see Figure 4	[2]						
	delay	V <sub>CC</sub> = 1.2 V		-	12	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.5	5.4	11.4	1.5	13.2	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.9	5.7	1.0	6.6	ns
		$V_{CC} = 2.7 V$		1.5	2.9	4.9	1.5	6.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.4	4.4	1.0	5.9	ns
		LE to Qn; see Figure 5							
		V <sub>CC</sub> = 1.2 V		-	14	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.0	6.4	12.4	2.0	14.4	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	3.4	6.1	1.5	7.1	ns
		$V_{CC} = 2.7 V$		1.5	3.0	5.3	1.5	7.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	2.9	4.8	1.5	6.0	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 7	[2]						
		$V_{CC} = 1.2 V$		-	18	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.5	5.5	12.4	1.5	14.3	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	3.1	6.6	1.0	7.6	ns
		$V_{CC} = 2.7 V$		1.5	3.3	5.7	1.5	7.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.5	4.9	1.0	6.5	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 7	[2]						
		$V_{CC} = 1.2 V$		-	11	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.8	4.5	9.1	2.8	10.5	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.5	5.1	1.0	6.0	ns
		$V_{CC} = 2.7 V$		1.5	3.3	6.3	1.5	8.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.5	3.1	5.4	1.5	7.0	ns
t <sub>W</sub>	pulse width	LE HIGH; see Figure 5							
		$V_{CC}$ = 1.65 V to 1.95 V		5.0	-	-	5.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$		3.0	-	-	3.0	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		3.0	2.0	-	3.0	-	ns
t <sub>su</sub>	set-up time	Dn to LE; see Figure 6							
		$V_{CC}$ = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		2.0	-	-	2.0	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V		2.0	1.0	-	2.0	-	ns

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Symbol	Parameter	Conditions		T <sub>amb</sub> =	–40 °C to	+85 °C	–40 °C to	Unit	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>h</sub>	hold time	Dn to LE; see Figure 6							
		$V_{CC}$ = 1.65 V to 1.95 V		2.5	-	-	2.5	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		0.9	-	-	0.9	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		+0.9	-1.0	-	0.9	-	ns
t <sub>sk(o)</sub>	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power	per input; $V_I = GND$ to $V_{CC}$	<u>[4]</u>						
	dissipation capacitance	$V_{CC}$ = 1.65 V to 1.95 V		-	10.8	-	-	-	pF
	capacitance	$V_{CC}$ = 2.3 V to 2.7 V		-	13.0	-	-	-	pF
		$V_{CC}$ = 3.0 V to 3.6 V		-	15.0	-	-	-	pF

#### Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V 2.7 V and 3.3 V respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

 $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

 $t_{\text{dis}}$  is the same as  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}.$ 

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

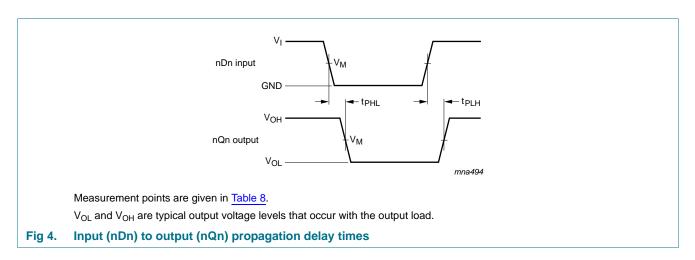
 $C_L$  = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs

## 11. Waveforms

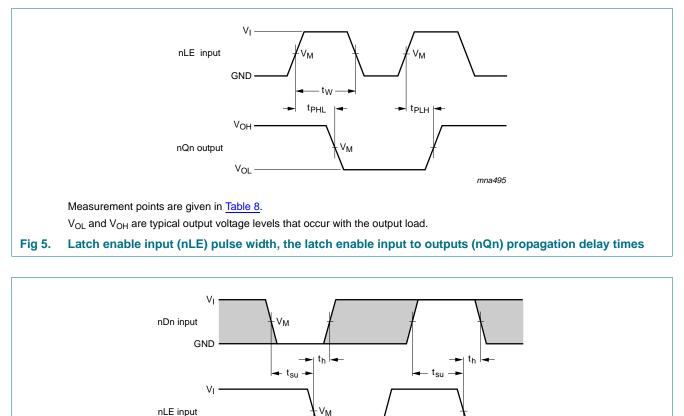


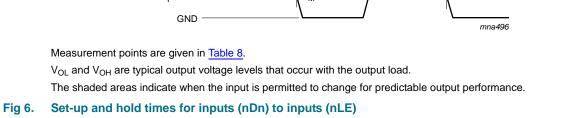
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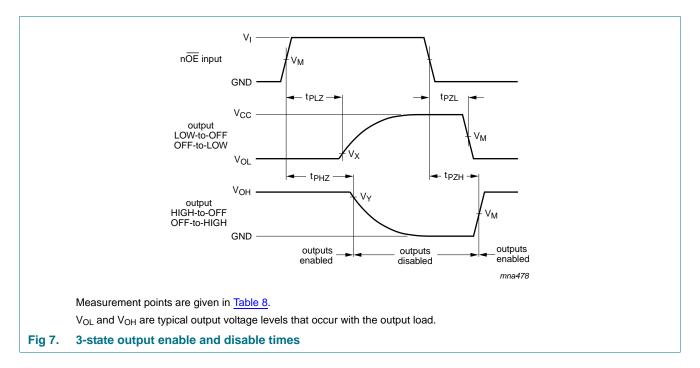
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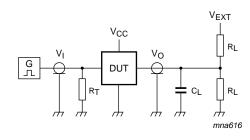


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#### Table 8. Measurement points

Supply voltage	Input		Output		
V <sub>CC</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
1.2 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	$V_{OH} - 0.15 \ V$
1.65 V to 1.95 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V
2.3 V to 2.7 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 \ V$
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 \ V$



Test data is given in Table 9. Definitions for test circuit:

- R<sub>L</sub> = Load resistance.
- C<sub>L</sub> = Load capacitance including jig and probe capacitance
- $R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

#### Fig 8. Test circuit for measuring switching times

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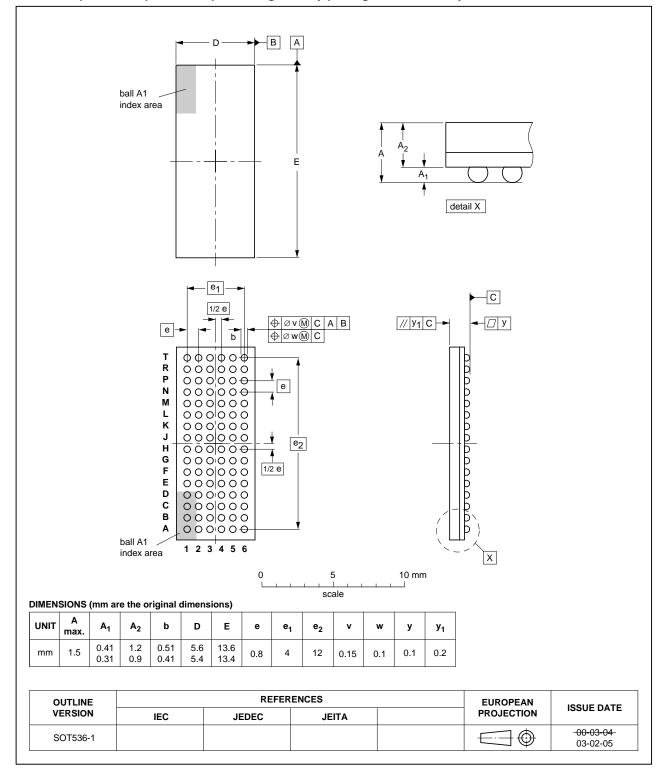
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### 32-bit transparant D-type latch with 5 V tolerant inputs/outputs; 3-state

Table 9. Test dat	а								
Supply voltage	Input	Input		Load		V <sub>EXT</sub>			
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>		
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND		
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND		
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND		
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND		
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND		

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## 12. Package outline



LFBGA96: plastic low profile fine-pitch ball grid array package; 96 balls; body 13.5 x 5.5 x 1.05 mm SOT536-1

#### Fig 9. Package outline SOT536-1 (LFBGA96)

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## **13. Abbreviations**

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 14. Revision history

#### Table 11. **Revision history Document ID Release date** Data sheet status **Change notice** Supersedes 74LVCH32373A v.4 20130128 Product data sheet 74LVCH32373A v.3 -Modifications: • Features list corrected (errata) 74LVCH32373A v.3 20130122 Product data sheet 74LVCH32373A v.2 \_ Modifications: The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. ٠ • Table 4, Table 5, Table 6, Table 7, Table 8 and Table 9: values added for lower voltage ranges. 74LVCH32373A v.2 20040519 Product specification 74LVCH32373A v.1 -74LVCH32373A v.1 19991124 Product specification -\_

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Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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[2] The term 'short data sheet' is explained in section "Definitions"

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### 32-bit transparant D-type latch with 5 V tolerant inputs/outputs; 3-state

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